

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT5638487

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
TAKUI SAKAGUCHI	07/02/2019
MASATOSHI AKETA	07/02/2019
YUKI NAKANO	07/02/2019
RECEIVING PARTY DATA	
Name:	ROHM CO., LTD.
Street Address:	21, SAIIN MIZOSAKI-CHO, UKYO-KU
City:	KYOTO-SHI, KYOTO
State/Country:	JAPAN
Postal Code:	615-8585
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16479886
CORRESPONDENCE DATA	
Fax Number:	(972)628-3616
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	9726283600
Email:	IPDOCKETING@MUNCKWILSON.COM
Correspondent Name:	BRIAN D. WALKER
Address Line 1:	P.O. DRAWER 800889
Address Line 4:	DALLAS, TEXAS 75380
ATTORNEY DOCKET NUMBER:	ROHM61-34676
NAME OF SUBMITTER:	BRIAN D. WALKER
SIGNATURE:	/BRIAN D. WALKER, REG. #37751/
DATE SIGNED:	07/26/2019
Total Attachments: 3	
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source=ROHM61-34676 ASSMTS EXE#page3.tif	

ASSIGNMENT AND DECLARATION UNDER 37 C.F.R. § 1.63
(For Use with Signed Application Data Sheet)Title of Invention: **SEMICONDUCTOR DEVICE**

This assignment and declaration are directed to (check one):

- the attached application;
 the application identified by the attorney docket no. and title of invention given above;
 United States Application or PCT International Application No. PCT/JP2018/002357,
filed January 25, 2018.

ASSIGNMENT

For good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, as a below-named inventor I have sold and assigned, and by these presents hereby sell and assign, unto:

Name of Assignee: **ROHM CO., LTD.**Address of Assignee: **21, Sa'in Mizosaki-cho, Ukyo-ku, Kyoto-shi, Kyoto 615-8585 Japan**

(hereinafter ASSIGNEE) all my right, title, and interest for the United States, its territories, and possessions in and to the above-identified invention and United States patent application, including any and all divisions or continuations thereof, and in and to any and all Letters Patent of the United States that may issue on any such application or for said invention, including any and all reissues or extensions thereof, to be held and enjoyed by said ASSIGNEE, its successors, or assigns to the full end of the term or terms for which any and all such Letters Patent may be granted as fully and entirely as would have been held and enjoyed by me had this Assignment not been made.

I hereby authorize and request the Director of the U.S. Patent and Trademark Office to issue any and all such Letters Patent to said ASSIGNEE, its successors, or assigns in accordance herewith.

I warrant and covenant that I have the full and unencumbered right to sell and assign the interests herein sold and assigned and that I have not executed and will not execute any document or instrument in conflict herewith.

I further covenant and agree that I will communicate to said ASSIGNEE, its successors, legal representatives, or assigns all information known to me relating to said invention or patent application and that I will execute and deliver any papers, make all rightful oaths, testify in any legal proceedings, and perform all other lawful acts deemed necessary or desirable by said ASSIGNEE, its successors, legal representatives, or assigns to perfect title to said invention, to said application including divisions and continuations thereof and to any and all Letters Patent that may be granted therefor or thereon, including reissues or extensions, in said ASSIGNEE, its successors, or assigns, or to assist said ASSIGNEE, its successors, legal representatives, or assigns in obtaining, reissuing, or enforcing Letters Patent of the United States for said invention.

DECLARATION

As a below-named inventor, I hereby declare that:

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. § 1001 by fine or imprisonment of not more than five (5) years, or both.

Signature: _____

Takui SakaguchiJul. 2, 2019

Inventor: _____

Takui SAKAGUCHI

DATE

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Signature:

Masatoshi Aketa

Jul. 02, 2019

Inventor:

Masatoshi AKETA

DATE

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Signature: Yuki NAKANO Jul. 2, 2019

Inventor: Yuki NAKANO DATE

PATENT